

- Meets IBM 360/370 I/O Interface Specification GA22-6974-3 (Also See SN75ALS130)
- Minimum Output Voltage of 3.11 V at $I_{OH} = -60$ mA
- Fault-Flag Circuit Output Signals Driver Output Fault
- Fault-Detection Current Limit Circuit Minimizes Power Dissipation During a Fault Condition
- Advanced Low-Power Schottky Circuitry
- Dual Common Enable
- Individual Fault Flags
- Designed to Be an Improved Replacement for the MC3481

description

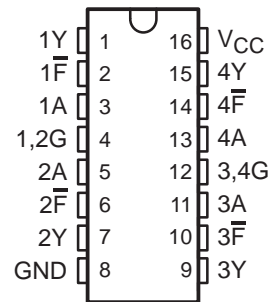
The SN75ALS126 quadruple line driver is designed to meet the IBM 360/370 I/O specification GA22-6974-3. The output voltage is 3.11 V minimum (at $I_{OH} = -59.3$ mA) over the recommended ranges of supply voltage (4.5 V to 5.95 V) and temperature. Driver outputs use a fault-detection current-limit circuit to allow high drive current but still minimize power dissipation when the output is shorted to ground. The SN75ALS126 is compatible with standard TTL logic and supply voltages.

The SN75ALS126 employs the IMPACT™ process to achieve fast switching speeds and low power dissipation. Fault-flag circuitry is designed to sense and signal a line short on any Y line. Upon detecting an output fault condition, the fault-flag circuit forces the driver output into a low state and signals a fault condition by causing the fault-flag output to go low.

The SN75ALS126 can drive a 50-Ω load as required in the IBM GA22-6974-3 specification or a 90-Ω load as used in many I/O systems. Optimum performance can be achieved when the device is used with either the SN75127, SN75128, or SN75129 line receivers.

The SN75ALS126 is characterized for operation from 0°C to 70°C.

**D OR N PACKAGE
(TOP VIEW)**



FUNCTION TABLE

INPUTS		OUTPUTS	
G	A	Y	F-bar
L	X	L	H
H	H	H	H
H	H	S	L

H = high level, L = low level,
X = irrelevant,
S = shorted to GND

IMPACT is a trademark of Texas Instruments Incorporated

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



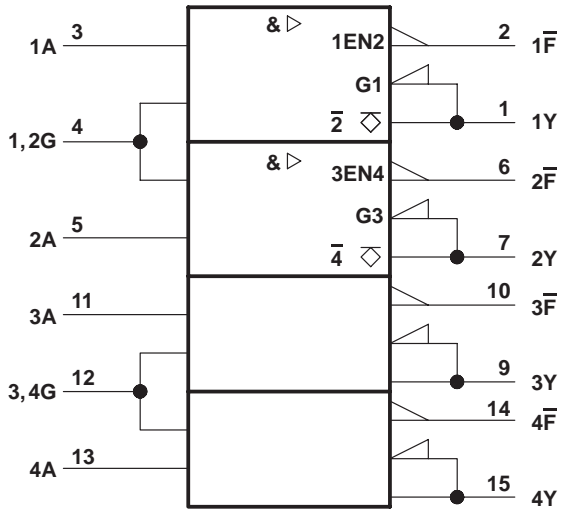
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1993, Texas Instruments Incorporated

SN75ALS126 QUADRUPLE LINE DRIVER

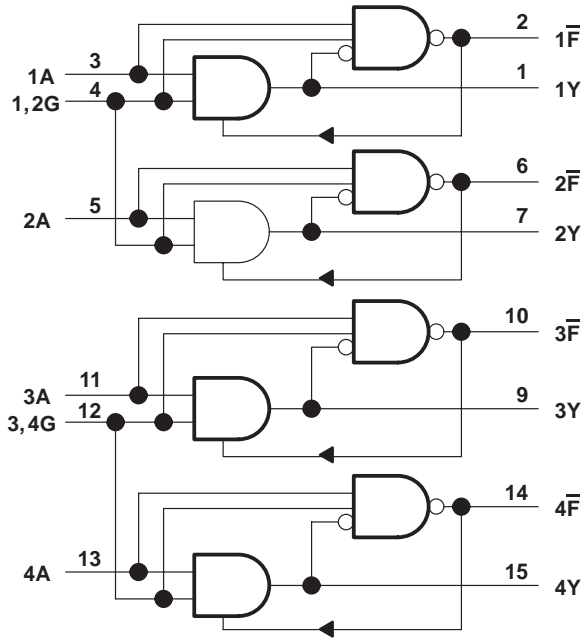
SLLS016C – FEBRUARY 1986 – REVISED FEBRUARY 1993

logic symbol†

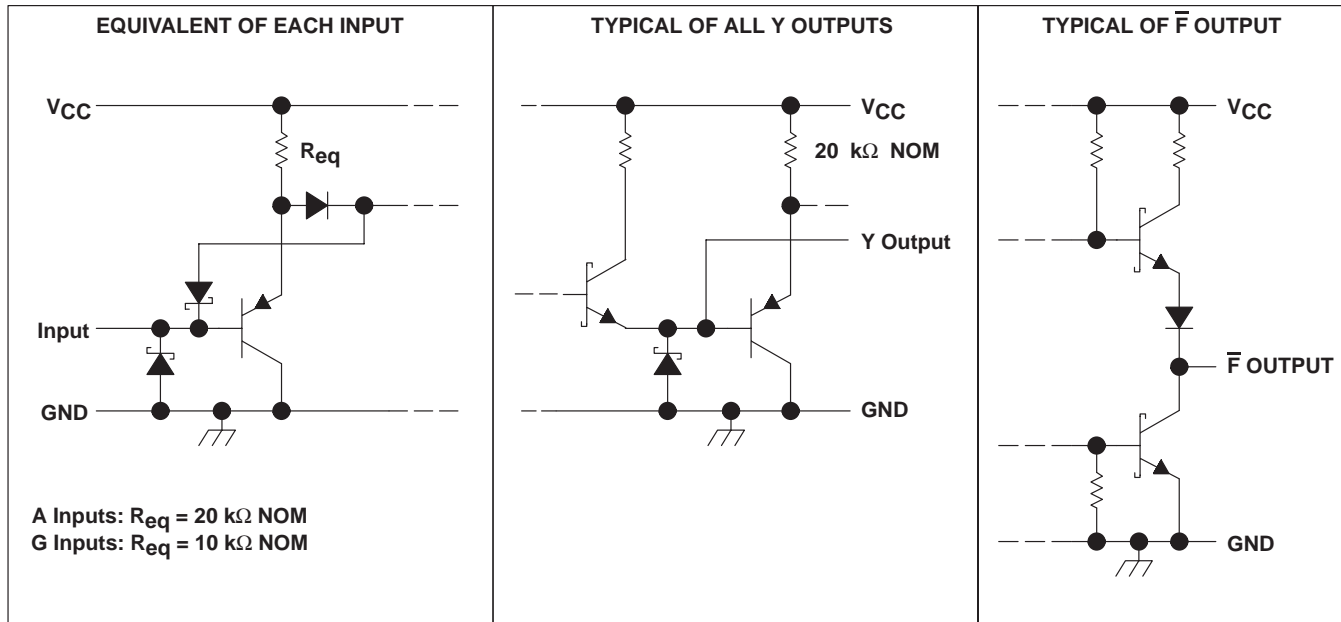


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC}	7 V
Input voltage	7 V
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range	0°C to 70°C
Storage temperature range	– 65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING
D	950 mW	7.6 mW/°C	608 mW
N	1150 mW	9.2 mW/°C	736 mW

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	4.5	5	5.95	V
High-level input voltage, V_{IH}	2			V
Low-level input voltage, V_{IL}			0.8	V
High-level output current, I_{OH}			– 59.3	mA
Operating free-air temperature, T_A	0		70	°C

SN75ALS126

QUADRUPLE LINE DRIVER

SLLS016C – FEBRUARY 1986 – REVISED FEBRUARY 1993

electrical characteristics over recommended operating free-air temperature range

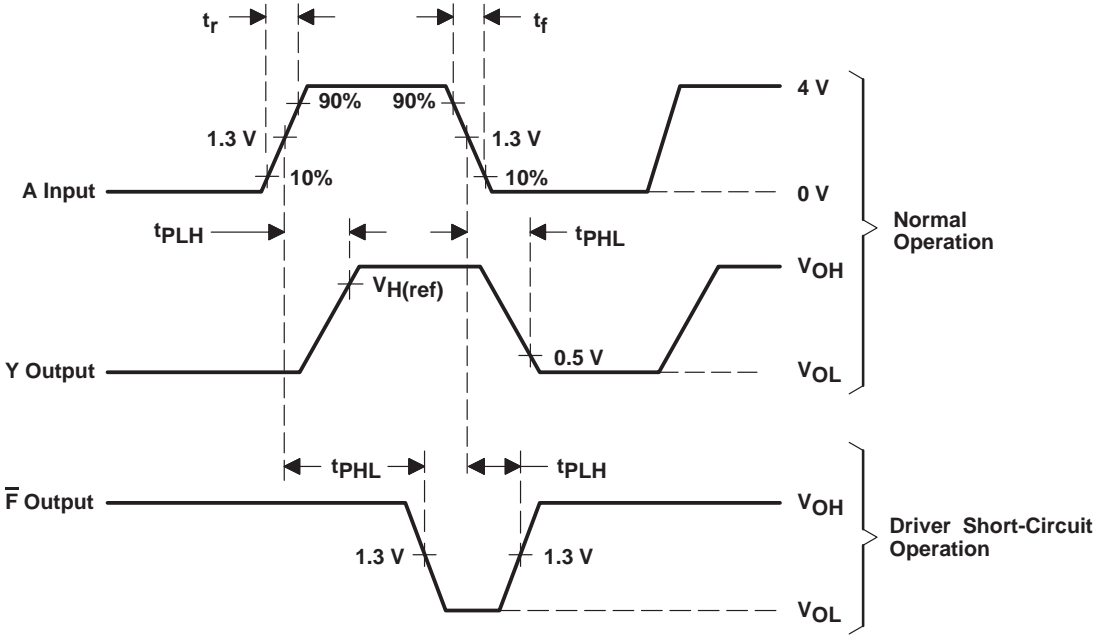
PARAMETER			TEST CONDITIONS	MIN	MAX	UNIT
V _{IK}	Input clamp voltage	A,G	V _{CC} = 4.5 V, I _I = -18 mA		-1.5	V
V _{OH}	High-level output voltage	Y	V _{CC} = 4.5 V, I _{OH} = -59.3 mA, V _{IH} = 2 V	3.11		V
		Y	V _{CC} = 5.25 V, I _{OH} = -41 mA, V _{IH} = 2 V	3.9		
		\bar{F}	V _{CC} = 4.5 V, I _{OH} = -400 μ A, V _{IH} = 2 V	2.5		
V _{OL}	Low-level output voltage	Y	V _{CC} = 5.5 V, I _{OL} = -240 μ A, V _{IL} = 0.8 V		0.15	V
		Y	V _{CC} = 5.95 V, I _{OL} = -1 mA, V _{IL} = 0.8 V		0.15	
		\bar{F}	V _{CC} = 4.5 V, I _{OL} = 8 mA, Y at 0 V		0.5	
I _{O(off)}	Off-state output current	Y	V _{CC} = 4.5 V, V _{IL} = 0, V _O = 3.11 V		100	μ A
		Y	V _{CC} = 0 V, V _{IL} = 0, V _O = 3.11 V		200	
I _I	Input current	A	V _{CC} = 4.5 V, V _I = 5.5 V		100	μ A
		G		400		
I _{IH}	High-level input current	A	V _{CC} = 4.5 V, V _I = 2.7 V		20	μ A
		G		80		
I _{IL}	Low-level input current	A	V _{CC} = 5.95 V, V _I = 0.4 V		-250	μ A
		G		-1000		
I _{OS}	Short-circuit output	Y	V _{CC} = 5.5 V, V _O = 0, V _{IH} = 2.7 V		-5	mA
		\bar{F}	V _{CC} = 5.5 V, V _O = 0	-15	-100	
		Y	V _{CC} = 5.95 V, V _O = 0, V _{IH} = 2.7 V		-5	
		\bar{F}	V _{CC} = 5.95 V, V _O = 0	-15	-110	
I _{CCH}	Supply current, all outputs high		V _{CC} = 5.5 V, No load, V _{IH} = 2.7 V		25	mA
			V _{CC} = 5.95 V, No load, V _{IH} = 2.7 V		27	
I _{CCL}	Supply current, Y outputs low		V _{CC} = 5.5 V, No load, V _{IL} = 0.4 V		45	mA
			V _{CC} = 5.95 V, No load, V _{IL} = 0.4 V		47	

switching characteristics over recommended operating free-air temperature range

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT	
t _{PLH}	A	Y	V _{CC} = 4.5 V to 5.5 V, R _L = 50 Ω , See Figures 1 and 2	C _L = 50 pF, V _{H(ref)} = 3.11 V,		30	ns
t _{PHL}						28	ns
t _{PLH} /t _{PHL}					Ratio of propagation delay times	0.3	3
t _{PLH}	A	Y	V _{CC} = 5.25 V to 5.95 V, R _L = 90 Ω , See Figures 1 and 2	C _L = 50 pF, V _{H(ref)} = 3.9 V,		34	ns
t _{PHL}						34	ns
t _{PLH}	A	\bar{F}	V _{CC} = 5 V, C _L = 15 pF,	R _L = 2 k Ω , See Figures 1 and 2		45	ns
t _{PHL}						75	ns

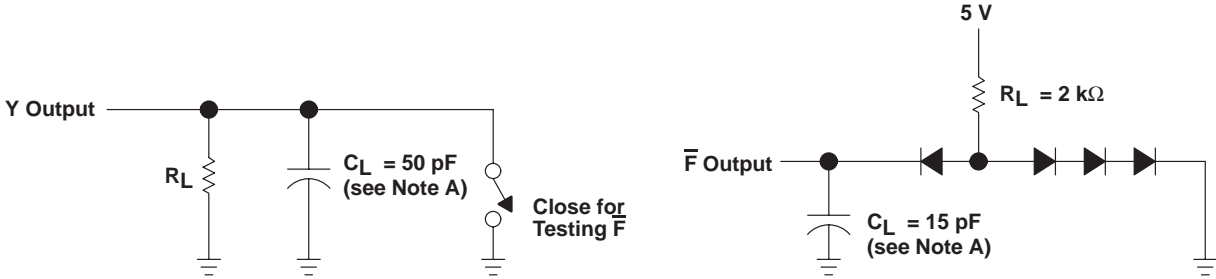


PARAMETER MEASUREMENT INFORMATION



NOTE A: The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle \leq 50%, $t_r \leq$ 6 ns, $t_f \leq$ 6 ns, $Z_O \approx$ 50 Ω .

Figure 1. Input and Output Voltage Waveforms



NOTE A: C_L includes probe and stray capacitance.

Figure 2. Switching Characteristics Load Circuits

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75ALS126D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265